SKKD 162, SKKE 162

SEMIPACK® 2

V_{RSM} V	V_{RRM} V	I_{FRMS} = 310 A (maximum value for continuous operation) I_{FAV} = 160 A (sin. 180; T_c = 95 °C)		
900	800	SKKD 162/08	SKKE 162/08	
1300	1200	SKKD 162/12	SKKE162/12	
1500	1400	SKKD 162/14	SKKE 162/14	
1700	1600	SKKD 162/16	SKKE 162/16	
1900	1800	SKKD 162/18	SKKE 162/18	
2100	2000	SKKD 162/20H4		
2300	2200	SKKD 162/22H4		

Rectifier Diode Modules

SKKD 162

SKKE 162

Features

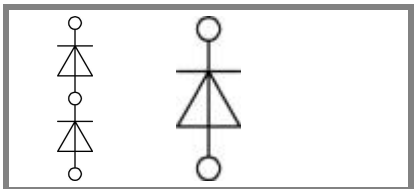
- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

Typical Applications*

- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

1) SKKD types only

Symbol	Conditions	Values	Units
I_{FAV}	sin. 180; T_c = 85 (100) °C	195 (150)	A
I_D	P3/180; T_a = 45 °C; B2 / B6	90 / 115	A
	P3/180F; T_a = 35 °C; B2 / B6	210 / 260	A
I_{FSM}	T_{vj} = 25 °C; 10 ms	6000	A
	T_{vj} = 125 °C; 10 ms	5000	A
i^2t	T_{vj} = 25 °C; 8,3 ... 10 ms	180000	A^2s
	T_{vj} = 125 °C; 8,3 ... 10 ms	125000	A^2s
V_F	T_{vj} = 25 °C; I_F = 500 A	max. 1,5	V
$V_{(TO)}$	T_{vj} = 135 °C	max. 0,85	V
r_T	T_{vj} = 135 °C	max. 1,2	mΩ
I_{RD}	T_{vj} = 135 °C; V_{RD} = V_{RRM}	max. 9	mA
$R_{th(j-c)}$	per diode / per module 1)	0,18 / 0,09	K/W
$R_{th(c-s)}$	per diode / per module 1)	0,1 / 0,05	K/W
T_{vj}		- 40 ... + 135	°C
T_{stg}		- 40 ... + 135	°C
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 / 3000	V~
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min. for SKK ...H4	4800 / 4000	V~
M_s	to heatsink	5 ± 15 %	Nm
M_t	to terminals	5 ± 15 %	Nm
a		5 * 9,81	m/s^2
m	approx.	165	g
Case	SKKD	A 23	
	SKKE	A 24	



SKKD SKKE

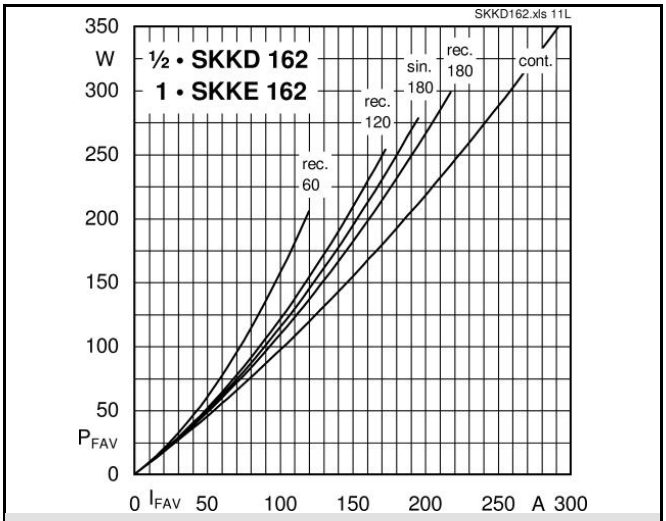


Fig. 11L Power dissipation per diode vs. forward current

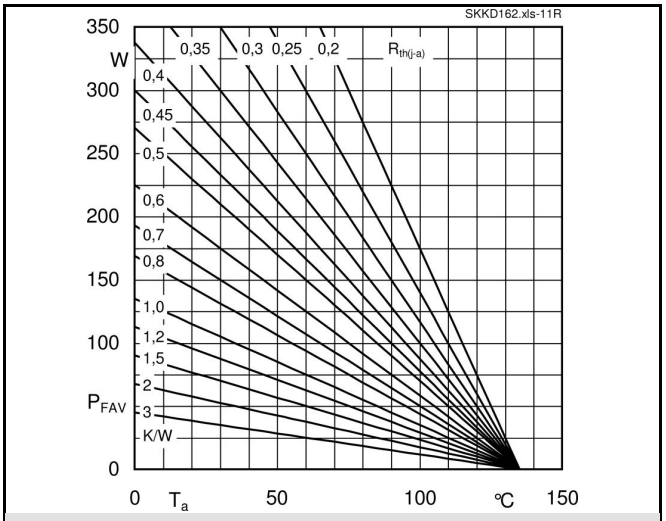


Fig. 11R Power dissipation per diode vs. ambient temperature

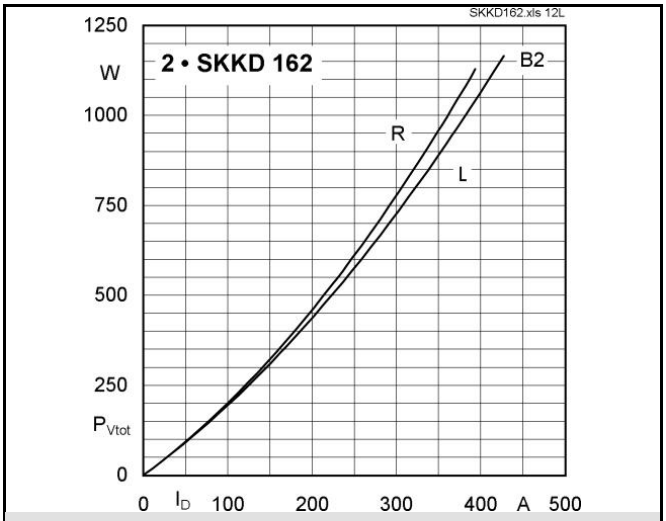


Fig. 12L Power dissipation of two modules vs. direct current

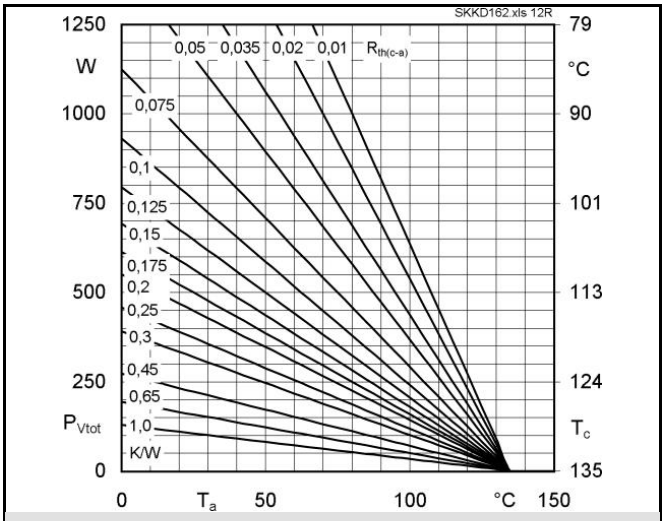


Fig. 12R Power dissipation of two modules vs. case temperature

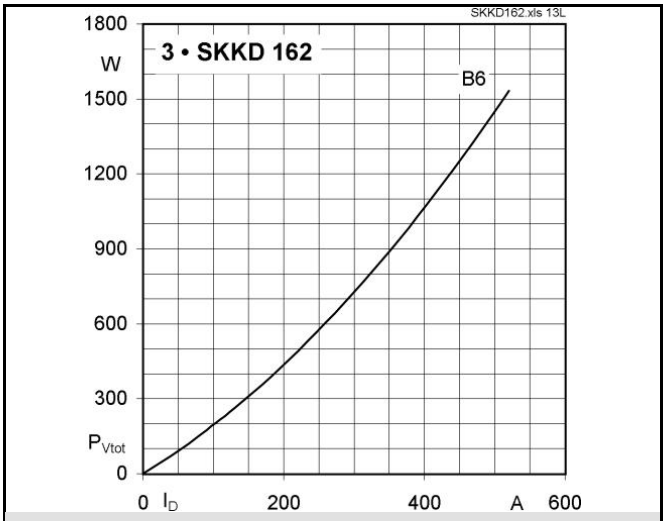


Fig. 13L Power dissipation of three modules vs. direct current

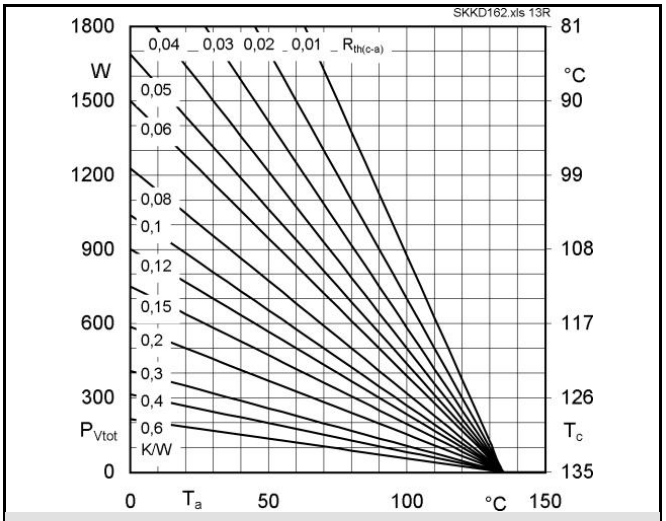


Fig. 13R Power dissipation of three modules vs. case temperature

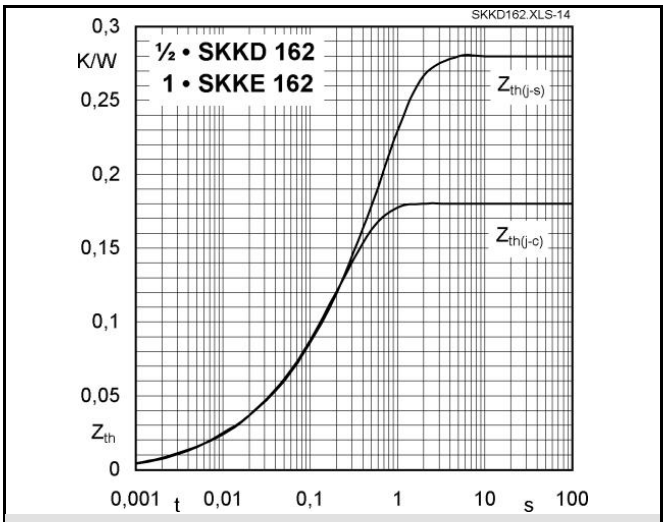


Fig. 14 Transient thermal impedance vs. time

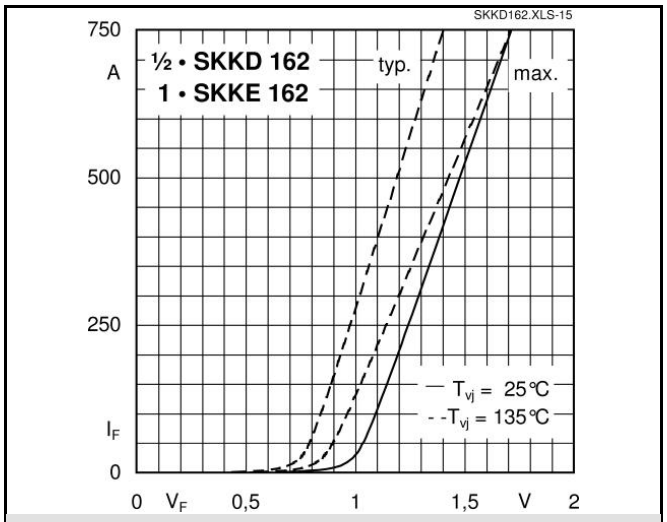


Fig. 15 Forward characteristics

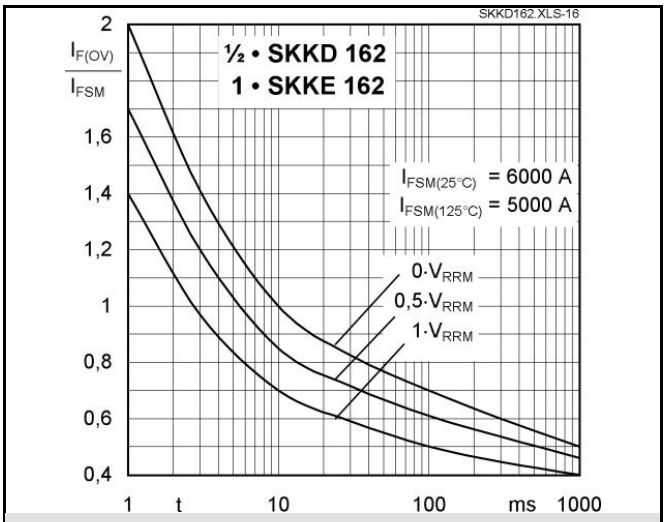
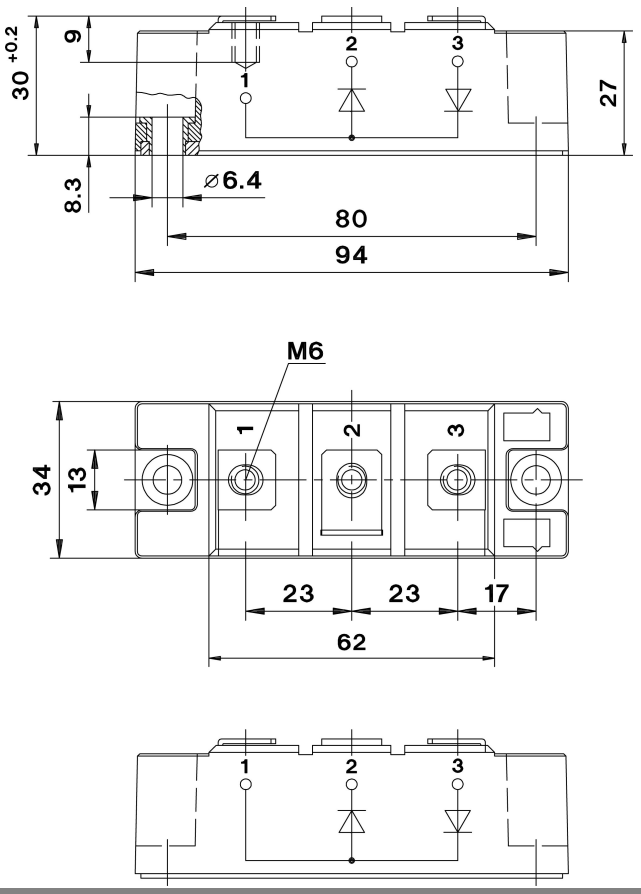
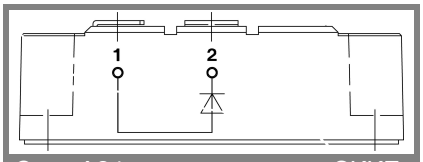


Fig. 16 Surge overload current vs. time

Dimensions in mm



Case A 23 (SKKD)



Case A24 SKKE

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

